Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

ABSOLUTE MAXIMUM RATINGS

V+ to GND .....-0.3V to +120V
V_{DD} to GND .....-0.3V to +40V
V_{CC} to GND .....-0.3V to +12.5V
OPTO, NDRV, SS_$\overline{SHDN}$, CS to GND .....-0.3V to V_{CC} + 0.3V
V_{DD} and V_{CC} Current 20mA
NDRV Current Continuous.....25mA
NDRV Current for Less than 1µs.....±1A

Continuous Power Dissipation (T_A = +70°C)
8-Pin SO (derate 5.88mW/°C above +70°C) 471mW
Operating Temperature Range.....-40°C to +85°C
Storage Temperature Range.....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DD} = 13V, a 10µF capacitor connects V_{CC} to GND, V_{CS} = 0, V+ = 48V, 0.1µF capacitor connected to SS_$\overline{SHDN}$, NDRV = open circuit, OPTO = GND, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY CURRENT						
V+ Supply Current	$I_{V+(NS)}$	V_{DD} = 0, V+ = 110V, driver not switching		0.85	1.3	mA
	$I_{V+(S)}$	V+ = 110V, V_{DD} = 0, V_{OPTO} = 4V, driver switching		1.4	2.6	
V+ Supply Current After Startup		V+ = 110V, V_{DD} = 13V, V_{OPTO} = 4V		11		µA
V_{DD} Supply Current	$I_{VDD(NS)}$	V_{DD} = 36V, driver not switching		0.9	1.3	mA
	$I_{VDD(S)}$	V_{DD} = 36V, driver switching, V_{OPTO} = 4V		1.9	2.7	
V+ Shutdown Current		$V_{SS\_\overline{SHDN}}$ = 0, V+ = 110V		190	290	µA
V_{DD} Shutdown Current		$V_{SS\_\overline{SHDN}}$ = 0		8	20	µA
PREREGULATOR/STARTUP						
V+ Input Voltage			18		110	V
V_{DD} Supply Voltage			13		36	V
INTERNAL REGULATORS (V_{CC})						
V_{CC} Output Voltage		Powered from V+, I_{CC} = 7.5mA, V_{DD} = 0	7.5	9.8	12	V
		Powered from V_{DD}, I_{CC} = 7.5mA	9.0	10.0	11.0	V
V_{CC} Undervoltage Lockout	V_{CC_UVLO}	V_{CC} falling		6.6		V
OUTPUT DRIVER						
Peak Source Current		V_{CC} = 11V, (externally forced)		570		mA
Peak Sink Current		V_{CC} = 11V, (externally forced)		1000		mA
NRDV High-Side Driver Resistance	R_{OH}	V_{CC} = 11V, externally forced, NDRV sourcing 50mA		4	12	Ω
NDRV Low Side Driver Resistance	R_{OL}	V_{CC} = 11V, externally forced, NDRV sinking 50mA		1.6	4	Ω
PWM COMPARATOR						
OPTO Input Bias Current		V_{OPTO} = $V_{SS\_\overline{SHDN}}$	-1.00		1.00	µA
OPTO Control Range			2		3	V
Slope Compensation	V_{SCOMP}	MAX5014		26		mV/µs

ELECTRICAL CHARACTERISTICS (continued)

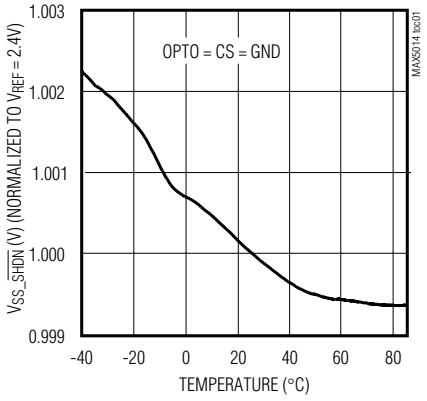
(V_{DD} = 13V, a 10µF capacitor connects V_{CC} to GND, V_{CS} = 0, V+ = 48V, 0.1µF capacitor connected to SS_$\overline{SHDN}$, NDRV = open circuit, OPTO = GND, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
THERMAL SHUTDOWN						
Thermal Shutdown Temperature				150		°C
Thermal Hysteresis				25		°C
CURRENT LIMIT						
CS Threshold Voltage	V_{ILIM}	V_{OPTO} = 4V	419	465	510	mV
CS Input Bias Current		0 ≤ V_{CS} ≤ 2V, V_{OPTO} = 4V	-1		1	µA
Current Limit Comparator Propagation Delay		25mV overdrive on CS, V_{OPTO} = 4V		180		ns
CS Blanking Time		V_{OPTO} = 4V		70		ns
OSCILLATOR						
Clock Frequency Range		V_{OPTO} = 4V	247	275	302	kHz
Max Duty Cycle		MAX5014, V_{OPTO} = 4V	75		85	%
		MAX5015, V_{OPTO} = 4V	44		50	
SOFT-START						
SS Source Current	I_{SSO}	$V_{SS\_\overline{SHDN}}$ = 0	2.0	4.6	6.5	µA
SS Sink Current			1.0			mA
Peak Soft-Start Voltage Clamp		No external load	2.331	2.420	2.500	V
Shutdown Threshold		$V_{SS\_\overline{SHDN}}$ falling	0.25	0.37	0.41	V
		$V_{SS\_\overline{SHDN}}$ rising	0.53	0.59	0.65	

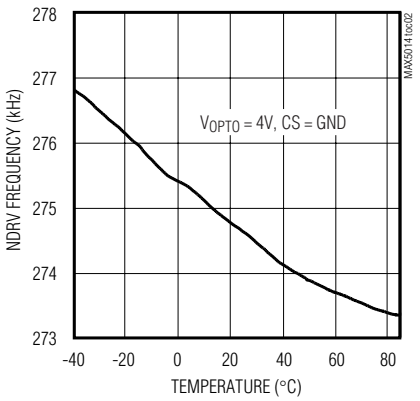
Typical Operating Characteristics

(V+ = 48V, V_{DD} = 13V, NRDV is open circuit, T_A = +25°C, unless otherwise noted.)

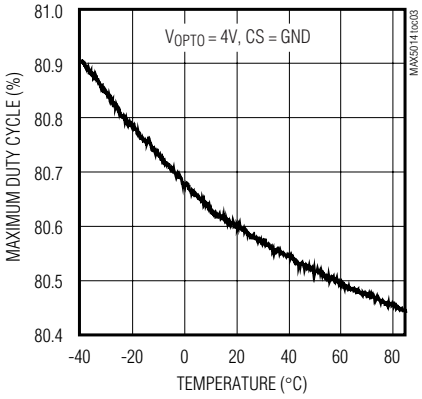
$V_{SS\_\overline{SHDN}}$ vs. TEMPERATURE (AT THE END OF SOFT-START)



NDRV FREQUENCY vs. TEMPERATURE



MAX5014 MAXIMUM DUTY CYCLE vs. TEMPERATURE

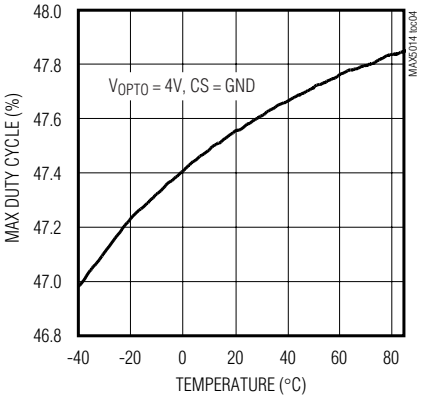


Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

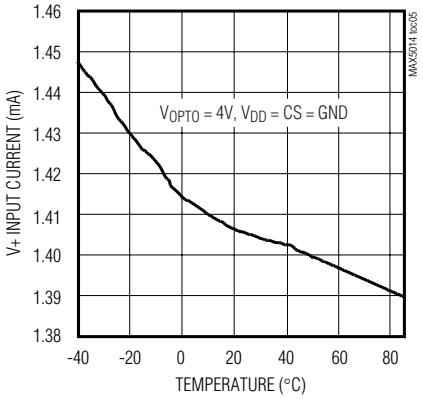
Typical Operating Characteristics (continued)

(V+ = 48V, V_{DD} = 13V, NRDV is open circuit, T_A = +25°C, unless otherwise noted.)

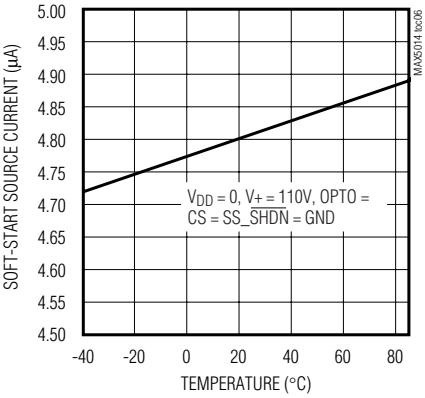
MAX5015 MAXIMUM DUTY CYCLE vs. TEMPERATURE



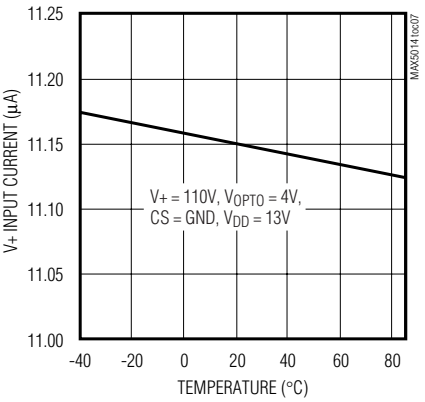
V+ SUPPLY CURRENT vs. TEMPERATURE



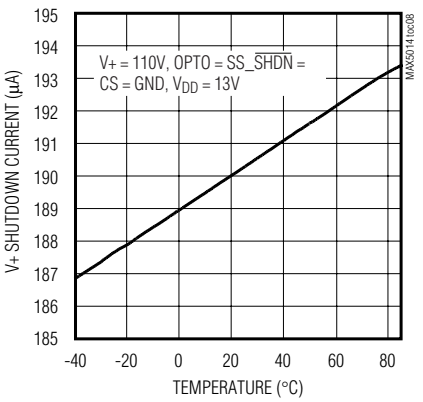
SOFT-START SOURCE CURRENT vs. TEMPERATURE



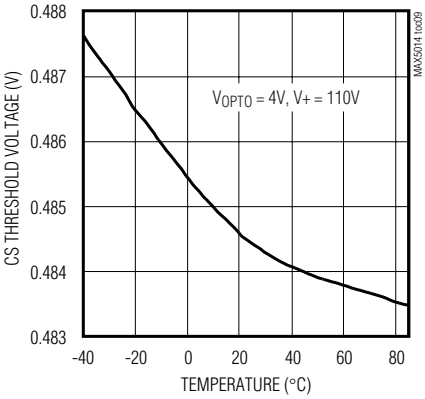
V+ INPUT CURRENT vs. TEMPERATURE (AFTER STARTUP)



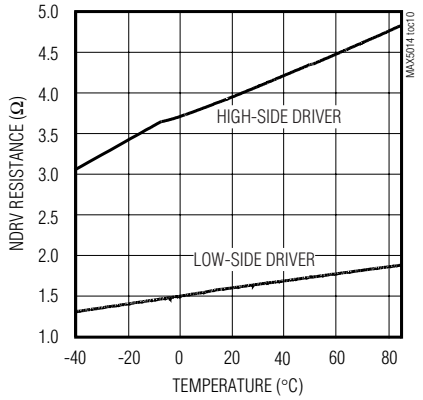
V+ SHUTDOWN CURRENT vs. TEMPERATURE



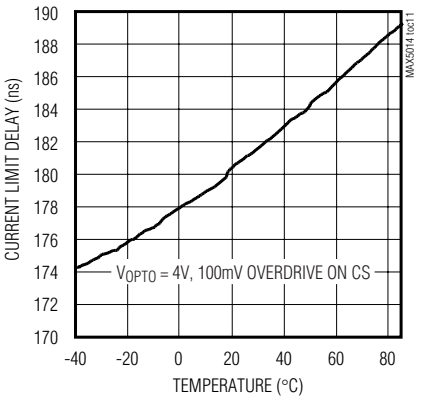
CS THRESHOLD VOLTAGE vs. TEMPERATURE



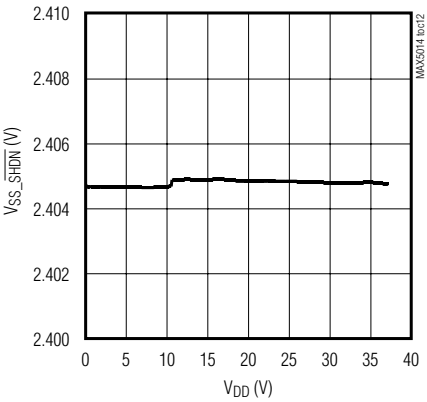
NDRV RESISTANCE vs. TEMPERATURE



CURRENT-LIMIT DELAY vs. TEMPERATURE



$V_{SS\_\overline{SHDN}}$ vs. V_{DD}

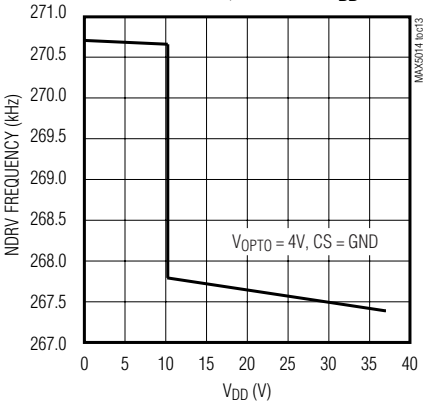


Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

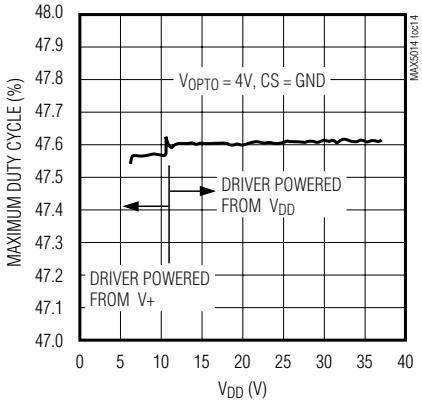
Typical Operating Characteristics (continued)

(V+ = 48V, V_{DD} = 13V, NRDV is open circuit, T_A = +25°C, unless otherwise noted.)

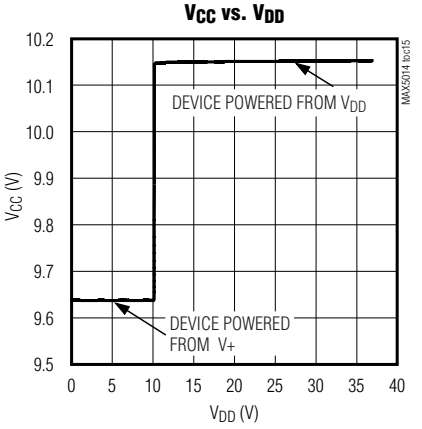
NDRV FREQUENCY vs. V_{DD}



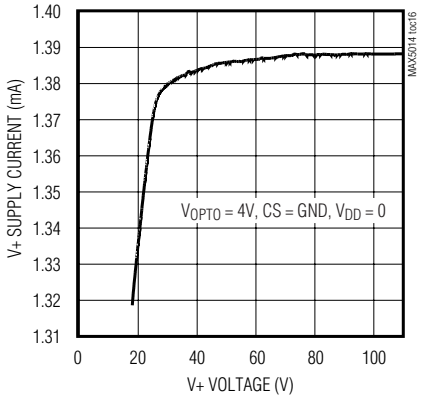
MAX5015 MAXIMUM DUTY CYCLE vs. V_{DD}



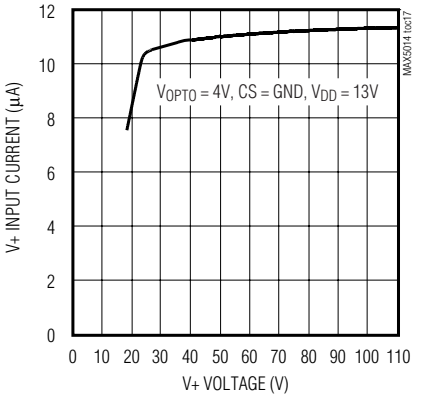
V_{CC} vs. V_{DD}



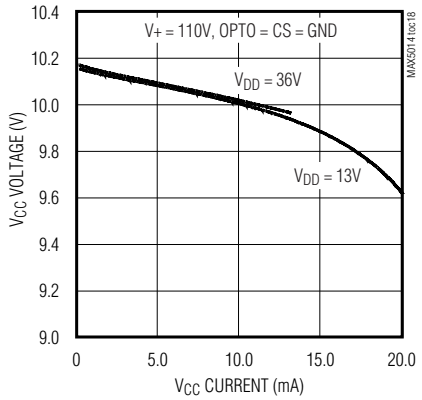
V+ SUPPLY CURRENT vs. V+ VOLTAGE



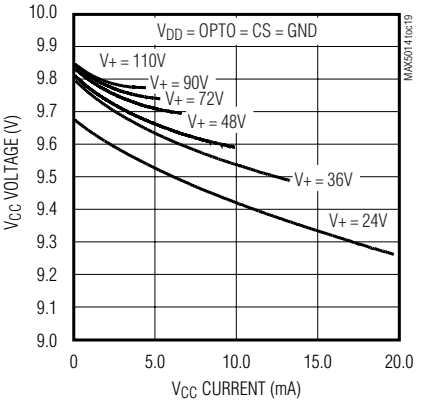
V+ INPUT CURRENT vs. VOLTAGE (AFTER STARTUP)



V_{CC} VOLTAGE vs. V_{CC} CURRENT



V_{CC} VOLTAGE vs. V_{CC} CURRENT



Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

Pin Description

PIN	NAME	FUNCTION
1	V+	High-Voltage Startup Input. Connect directly to an input voltage between 18V to 110V. Connects internally to a high-voltage linear regulator that generates V_{CC} during startup.
2	V_{DD}	V_{DD} is the Input of the Linear Regulator that Generates V_{CC}. For supply voltages less than 36V, V_{DD} and V+ can both be connected to the supply. For supply voltages greater than 36V, V_{DD} receives its power from the tertiary winding of the transformer and accepts voltages from 13V to 36V. Bypass to GND with a 4.7µF capacitor.
3	OPTO	Optocoupler Input. The control voltage range on this input is 2V to 3V.
4	SS_$\overline{SHDN}$	Soft-Start Timing Capacitor Connection. Ramp time to full current limit is approximately 0.45ms/nF. This pin is also the reference voltage output. Bypass with a minimum 10nF capacitor to GND. The device goes into shutdown when $V_{SS\_\overline{SHDN}}$ is pulled below 0.25V.
5	CS	Current Sense Input. Turns power switch off if V_{CS} rises above 465mV for cycle-by-cycle current limiting. CS is also the feedback for the current-mode controller. CS is connected to the PWM comparator through a leading edge blanking circuit.
6	GND	Ground
7	NDRV	Gate Drive. Drives a high-voltage external N-channel power MOSFET.
8	V_{CC}	Regulated IC Supply. Provides power for the entire IC. V_{CC} is regulated from V_{DD} during normal operation and from V+ during startup. Bypass V_{CC} with a 10µF tantalum capacitor in parallel with 0.1µF ceramic capacitor to GND.

Detailed Description

Use the MAX5014/MAX5015 PWM current-mode controllers to design flyback- or forward-mode power supplies. Current-mode operation simplifies control-loop design while enhancing loop stability. An internal high-voltage startup regulator allows the device to connect directly to the input supply without an external startup resistor. Current from the internal regulator starts the controller. Once the tertiary winding voltage is established the internal regulator is switched off and bias current for running the IC is derived from the tertiary winding. The internal oscillator is set to 275kHz and trimmed to ±10%. This permits the use of small magnetic components to minimize board space. Both the MAX5014 and MAX5015 can be used in power supplies providing multiple output voltages. A functional diagram of the IC is shown in Figure 1. Typical applications circuits for forward and flyback topologies are shown in Figure 2 and Figure 3, respectively.

Current-Mode Control

The MAX5014/MAX5015 offer current-mode control operation with added features such as leading-edge blanking with dual internal path that only blanks the sensed current signal applied to the input of the PWM comparator. The current limit comparator monitors the CS pin at all times and provides cycle-by-cycle current limit without being blanked. The leading-edge blanking of the CS signal prevents the PWM comparator from prematurely terminating the on cycle. The CS signal contains a leading-edge spike that is the result of the MOSFET gate charge current, capacitive and diode reverse recovery current of the power circuit. Since this leading-edge spike is normally lower than the current limit comparator threshold, current limiting is not blanked and cycle-by-cycle current limiting is provided under all conditions.

Use the MAX5014 in discontinuous flyback applications where wide line voltage and load current variation is expected. Use the MAX5015 for single transistor forward converters where the maximum duty cycle must be limited to less than 50%.

Under certain conditions it may be advantageous to use a forward converter with greater than 50% duty cycle. For those cases use the MAX5014. The large duty cycle results in much lower operating primary RMS currents through the MOSFET switch and in most cases a smaller output filter inductor. The major disadvantage to this is that the MOSFET voltage rating must be higher and that slope compensation must be provided to stabilize the inner current loop. The MAX5014 provides internal slope compensation.

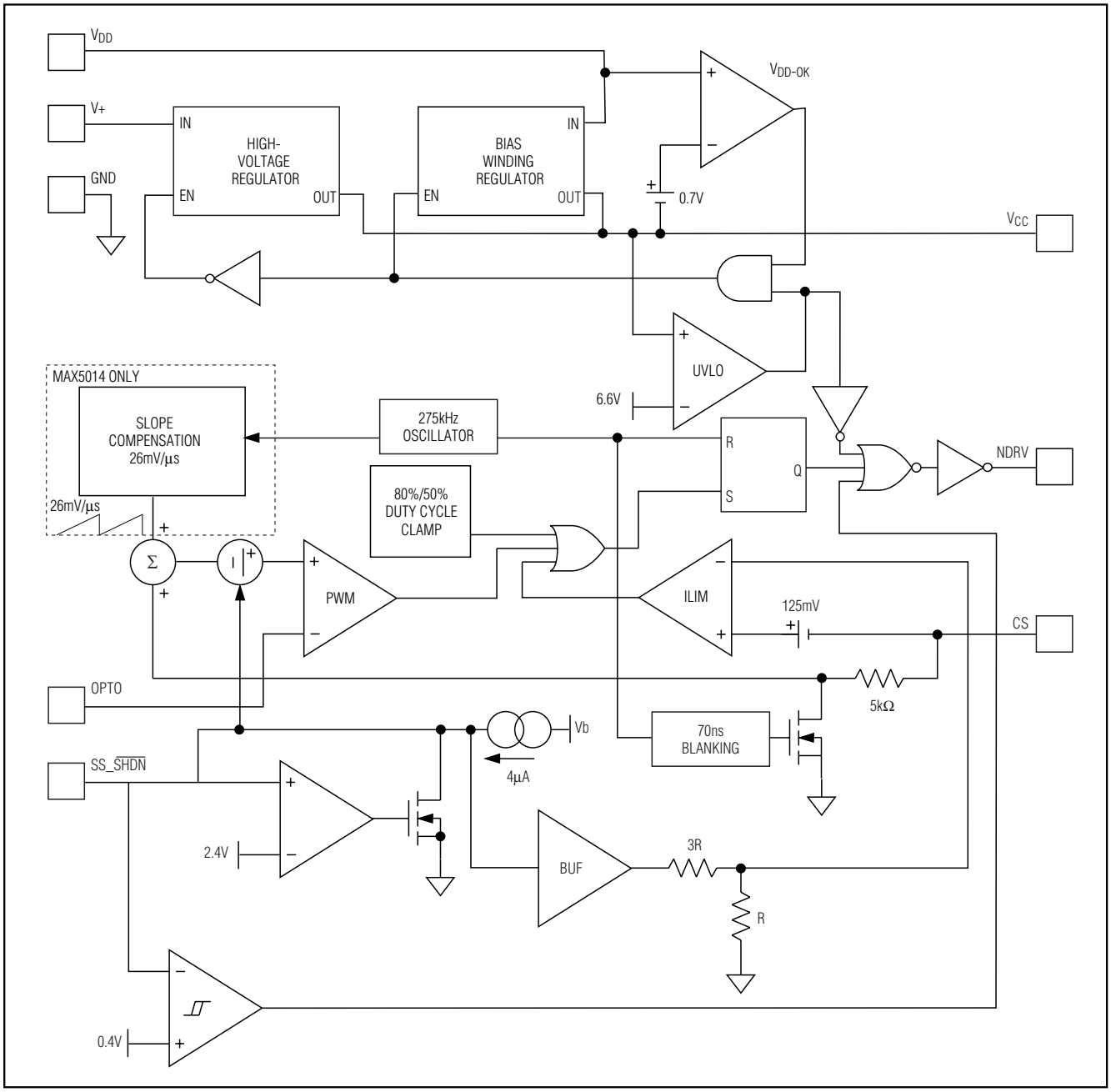


Figure 1. Functional Diagram

Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

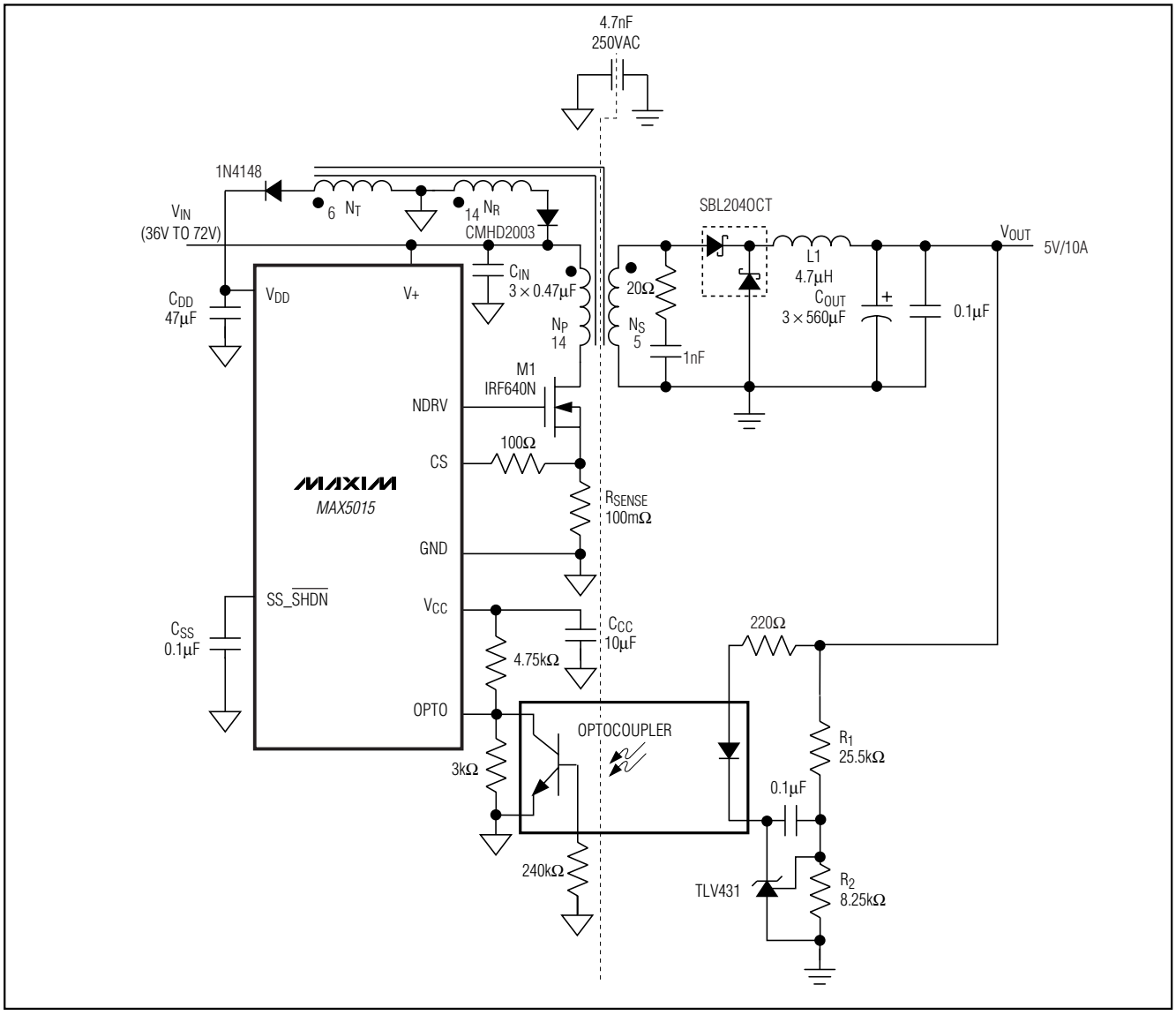


Figure 2. Forward Converter

Optocoupled Feedback

Isolated voltage feedback is achieved by using an optocoupler and a shunt regulator as shown in Figure 2. The output voltage set point accuracy is a function of the accuracy of the shunt regulator and feedback resistor-divider tolerance.

Internal Regulators

The internal regulators of the MAX5014/MAX5015 enable initial startup without a lossy startup resistor and regulate the voltage at the output of a tertiary (bias) winding to provide power for the IC. At startup V+ is regulated down to V_{CC} to provide bias for the device. The V_{DD} regulator then regulates from the output of the tertiary winding to V_{CC}. This architecture allows the tertiary winding to only have a small filter capacitor at its output thus eliminating the additional cost of a filter inductor.

When designing the tertiary winding calculate the number of turns so the minimum reflected voltage is always higher than 12.7V. The maximum reflected voltage must be less than 36V.

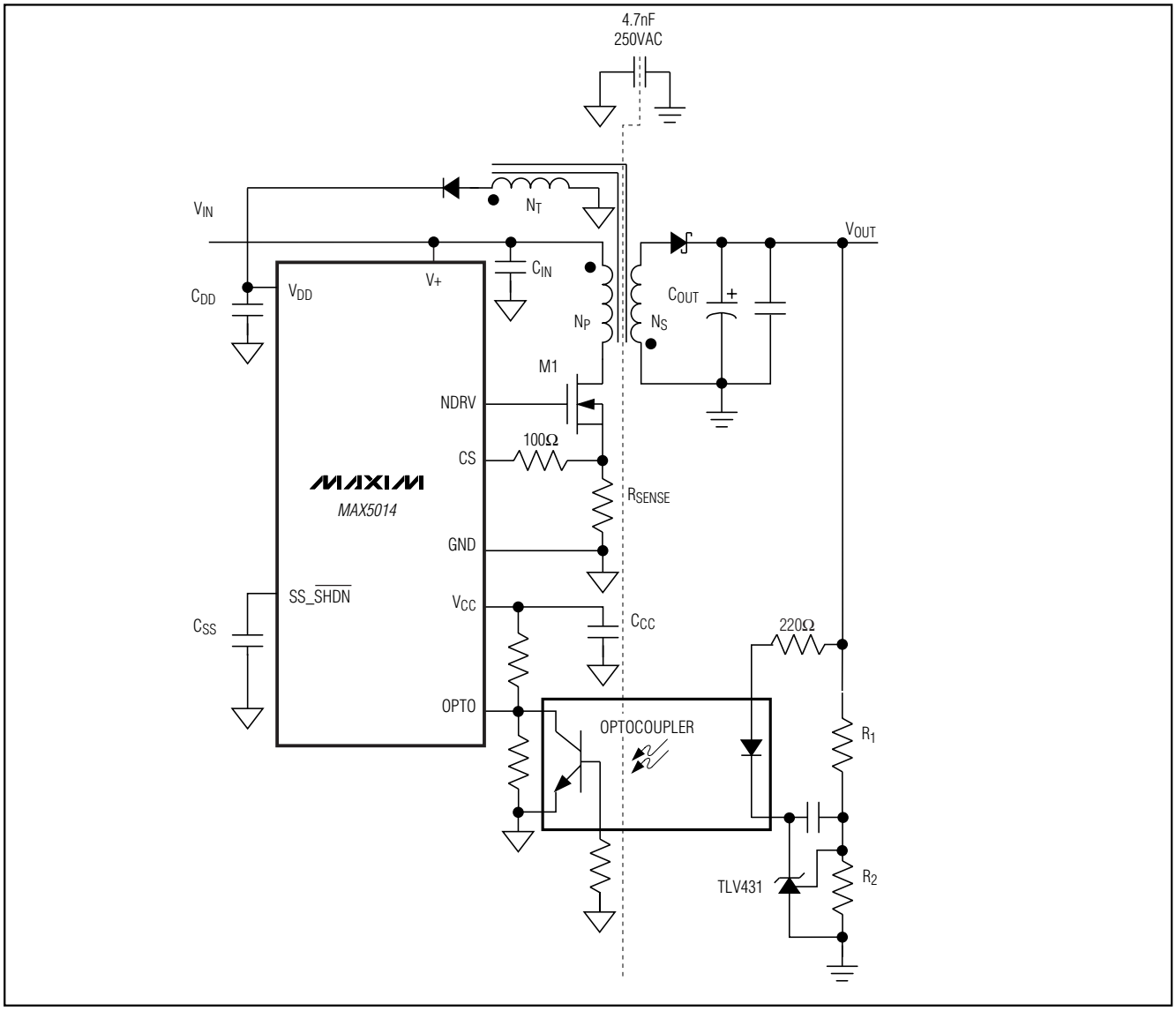


Figure 3. Flyback Converter

To reduce power dissipation the high-voltage regulator is disabled when the V_{DD} voltage reaches 12.7V. This greatly reduces power dissipation and improves efficiency. If V_{CC} falls below the undervoltage lockout threshold (V_{CC} = 6.6V), the low-voltage regulator is disabled, and soft-start is reinitiated. In undervoltage lockout the MOSFET driver output (NDRV) is held low.

If the input voltage range is between 13V and 36V, V+ and V_{DD} may be connected to the line voltage provided that the maximum power dissipation is not exceeded. This eliminates the need for a tertiary winding.

Undervoltage Lockout (UVLO), Soft-Start, and Shutdown

The soft-start feature of the MAX5014/MAX5015 allows the load voltage to ramp up in a controlled manner, thus eliminating output voltage overshoot.

While the part is in UVLO, the capacitor connected to the SS_SHDN pin is discharged. Upon coming out of UVLO an internal current source starts charging the capacitor to initiate the soft-start cycle. Use the following equation to calculate total soft-start time:

Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

$$t_{startup} = 0.45 \frac{ms}{nF} \times C_{ss}$$

where C_{SS} is the soft-start capacitor as shown in Figure 2.

Operation begins when $V_{SS\_\overline{SHDN}}$ ramps above 0.6V. When soft-start has completed, $V_{SS\_\overline{SHDN}}$ is regulated to 2.4V, the internal voltage reference. Pull $V_{SS\_\overline{SHDN}}$ below 0.25V to disable the controller.

Undervoltage lockout shuts down the controller when V_{CC} is less than 6.6V. The regulators for V+ and the reference remain on during shutdown.

Current-Sense Comparator

The current-sense (CS) comparator and its associated logic limit the peak current through the MOSFET. Current is sensed at CS as a voltage across a sense resistor between the source of the MOSFET and GND. To reduce switching noise, connect CS to the external MOSFET source through a 100Ω resistor or an RC low-pass filter (Figures 2, 3). Select the current-sense resistor, R_{SENSE} according to the following equation:

$$R_{SENSE} = 0.465V / I_{LimPrimary}$$

where $I_{LimPrimary}$ is the maximum peak primary-side current.

When V_{CS} > 465mV, the power MOSFET switches off. The propagation delay from the time the switch current reaches the trip level to the driver turn-off time is 170ns.

PWM Comparator and Slope Compensation

An internal 275kHz oscillator determines the switching frequency of the controller. At the beginning of each cycle, NDRV switches the N-channel MOSFET on. NDRV switches the external MOSFET off after the maximum duty cycle has been reached, regardless of the feedback.

The MAX5014 uses an internal ramp generator for slope compensation. The internal ramp signal is reset at the beginning of each cycle and slews at 26mV/µs.

The PWM comparator uses the instantaneous current, the error voltage, the internal reference, and the slope compensation (MAX5014 only) to determine when to switch the N-channel MOSFET off. In normal operation the N-channel MOSFET turns off when:

$$I_{PRIMARY} \times R_{SENSE} > V_{OPTO} - V_{REF} - VS_{COMP}$$

where $I_{PRIMARY}$ is the current through the N-channel MOSFET, V_{REF} is the 2.4V internal reference and V_{SCOMP} is a ramp function starting at 0 and slewing at 26mV/µs (MAX5014 only). When using the MAX5014 in a forward-converter configuration the following condition must be met to avoid control-loop subharmonic oscillations:

$$\frac{N_S}{N_P} \times \frac{k \times R_{SENSE} \times V_{OUT}}{L} = 26mV/\mu s$$

where k = 0.75 to 1, and N_S and N_P are the number of turns on the secondary and primary side of the transformer, respectively. L is the output filter inductor. This makes the output inductor current downslope as referenced across R_{SENSE} equal to the slope compensation. The controller responds to transients within one cycle when this condition is met.

N-Channel MOSFET Gate Driver

NDRV drives an N-channel MOSFET. NDRV sources and sinks large transient currents to charge and discharge the MOSFET gate. To support such switching transients, bypass V_{CC} with a ceramic capacitor. The average current as a result of switching the MOSFET is the product of the total gate charge and the operating frequency. It is this current plus the DC quiescent current that determines the total operating current.

Applications Information

Design Example

The following is a general procedure for designing a forward converter (Figure 2) using the MAX5015.

1) Determine the requirements.
2) Set the output voltage.
3) Calculate the transformer primary to secondary winding turns ratio.
4) Calculate the reset to primary winding turns ratio.
5) Calculate the tertiary to primary winding turns ratio.
6) Calculate the current-sense resistor value.
7) Calculate the output inductor value.
8) Select the output capacitor.

The circuit in Figure 2 was designed as follows:

1) 36V ≤ V_{IN} ≤ 72V, V_{OUT} = 5V, I_{OUT} = 10A, V_{RIPPLE} ≤ 50mV
2) To set the output voltage calculate the values of resistors R1 and R2 according to the following equation:

$$\frac{V_{REF}}{V_{OUT}} = \frac{R_2}{R_1 + R_2}$$

where V_{REF} is the reference voltage of the shunt regulator, and R_1 and R_2 are the resistors shown in Figures 2 and 3.

3) The turns ratio of the transformer is calculated based on the minimum input voltage and the lower limit of the maximum duty cycle for the MAX5015 (44%). To enable the use of MOSFETs with drain-source breakdown voltages of less than 200V use the MAX5015 with the 50% maximum duty cycle. Calculate the turns ratio according to the following equation:

$$\frac{N_S}{N_P} \geq \frac{V_{OUT} + (V_{D1} \times D_{MAX})}{D_{MAX} \times V_{IN\_MIN}}$$

where:

N_S/N_P = Turns ratio (N_S is the number of secondary turns and N_P is the number of primary turns).

V_{OUT} = Output voltage (5V).

V_{D1} = Voltage drop across D1 (typically 0.5V for power Schottky diodes).

D_{MAX} = Minimum value of maximum operating duty cycle (44%).

V_{IN_MIN} = Minimum Input voltage (36V).

In this example:

$$\frac{N_S}{N_P} \geq \frac{5V + (0.5V \times 0.44)}{0.44 \times 36V} = 0.330$$

Choose N_P based on core losses and DC resistance. Use the turns ratio to calculate N_S, rounding up to the nearest integer. In this example N_P = 14 and N_S = 5.

For a forward converter choose a transformer with a magnetizing inductance in the neighborhood of 200µH. Energy stored in the magnetizing inductance of a forward converter is not delivered to the load and must be returned back to the input; this is accomplished with the reset winding.

The transformer primary to secondary leakage inductance should be less than 1µH. Note that all leakage energy will be dissipated across the MOSFET. Snubber circuits may be used to direct some or all of the leakage energy to be dissipated across a resistor.

To calculate the minimum duty cycle (D_{MIN}) use the following equation:

$$D_{MIN} = \frac{V_{OUT}}{V_{IN\_MAX} \times \frac{N_S}{N_P} - V_{D1}} = 19.8$$

where V_{IN_MAX} is the maximum input voltage (72V).

4) The reset winding turns ratio (N_R/N_P) needs to be low enough to guarantee that the entire energy in the transformer is returned to V+ within the off cycle at the maximum duty cycle. Use the following equation to determine the reset winding turns ratio:

$$N_R \leq N_P \times \frac{1 - D_{MAX}'}{D_{MAX}'}$$

where:

N_R/N_P = Reset winding turns ratio.

D_{MAX}' = Maximum value of Maximum Duty Cycle.

$$N_R \leq 14 \times \frac{1 - 0.5}{0.5} = 14$$

Round N_R to the nearest smallest integer.

The turns ratio of the reset winding (N_R/N_P) will determine the peak voltage across the N-channel MOSFET.

Use the following equation to determine the maximum drain-source voltage across the N-channel MOSFET:

$$V_{DSMAX} \geq V_{IN\_MAX} \times \left(1 + \frac{N_P}{N_R}\right)$$

V_{DSMAX} = Maximum MOSFET drain-source voltage.

V_{IN_MAX} = Maximum input voltage.

$$V_{DSMAX} \geq 72V \times \left(1 + \frac{14}{14}\right) = 144V$$

Choose MOSFETs with appropriate avalanche power ratings to absorb any leakage energy.

5) Choose the tertiary winding turns ratio (N_T/N_P) so that the minimum input voltage provides the minimum operating voltage at V_{DD} (13V). Use the follow-

Current-Mode PWM Controllers with Integrated Startup Circuit for Isolated Power Supplies

ing equation to calculate the tertiary winding turns ratio:

$$\frac{V_{DDMIN}+0.7}{V_{IN\_MIN}}\times N_P \le N_T \le \frac{V_{DDMAX}+0.7}{V_{IN\_MAX}}\times N_P$$

where:

V_{DDMIN} is the minimum V_{DD} supply voltage (13V).

V_{DDMAX} is the maximum V_{DD} supply voltage (36V).

V_{IN_MIN} is the minimum input voltage (36V).

V_{IN_MAX} is the maximum input voltage (72V in this design example).

N_P is the number of turns of the primary winding.

N_T is the number of turns of the tertiary winding.

$$\frac{13.7}{36}\times 14 \le N_T \le \frac{36.7}{72}\times 14$$

$$5.33 \le N_T \le 7.14$$

Choose $N_T = 6$.

6) Choose R_{SENSE} according to the following equation:

$$R_{SENSE} \le \frac{V_{ILIM}}{\frac{N_S}{N_P}\times 1.2\times I_{OUTMAX}}$$

where:

V_{ILim} is the current-sense comparator trip threshold voltage (0.465V).

N_S/N_P is the secondary side turns ratio (5/14 in this example).

I_{OUTMAX} is the maximum DC output current (10A in this example).

$$R_{SENSE} \le \frac{0.465V}{\frac{5}{14}\times 1.2\times 10} = 109m\Omega$$

7) Choose the inductor value so that the peak ripple current (LIR) in the inductor is between 10% and 20% of the maximum output current.

$$L \ge \frac{(V_{OUT}+V_D)\times(1-D_{MIN})}{2\times LIR\times 275kHz\times I_{OUTMAX}}$$

where V_D is the output Schottky diode forward voltage drop (0.5V) and LIR is the ratio of inductor ripple current to DC output current.

$$L \ge \frac{(5.5)\times(1-0.198)}{0.4\times 275kHz\times 10A} = 4.01\mu H$$

8) The size and ESR of the output filter capacitor determine the output ripple. Choose a capacitor with a low ESR to yield the required ripple voltage.

Use the following equations to calculate the peak-to-peak output ripple:

$$V_{RIPPLE} = \sqrt{V_{RIPPLE,ESR}^2 + V_{RIPPLE,C}^2}$$

where:

V_{RIPPLE} is the combined RMS output ripple due to $V_{RIPPLE,ESR}$, the ESR ripple, and $V_{RIPPLE,C}$, the capacitive ripple. Calculate the ESR ripple and capacitive ripple as follows:

$V_{RIPPLE,ESR} = I_{RIPPLE} \times ESR$

$V_{RIPPLE,C} = I_{RIPPLE}/(2 \times \pi \times 275kHz \times C_{OUT})$

Layout Recommendations

All connections carrying pulsed currents must be very short, be as wide as possible, and have a ground plane as a return path. The inductance of these connections must be kept to a minimum due to the high di/dt of the currents in high-frequency switching power converters.

Current loops must be analyzed in any layout proposed, and the internal area kept to a minimum to reduce radiated EMI. Ground planes must be kept as intact as possible.

Chip Information

TRANSISTOR COUNT: 589

PROCESS: BiCMOS

Table 1. Component Manufacturers

Power FETS	International Rectifier	www.irf.com
	Fairchild	www.fairchildsemi.com
	Vishay-Siliconix	www.vishay.com/brands/siliconix/main.html
Current-Sense Resistors	Dale-Vishay	www.vishay.com/brands/dale/main.html
	IRC	www.irctt.com/pages/index.cfm
Diodes	On Semi	www.onsemi.com
	General Semiconductor	www.gensemi.com
	Central Semiconductor	www.centralsemi.com
Capacitors	Sanyo	www.sanyo.com
	Taiyo Yuden	www.t-yuden.com
	AVX	www.avxcorp.com
Magnetics	Coiltronics	www.cooperet.com
	Coilcraft	www.coilcraft.com
	Pulse Engineering	www.pulseeng.com

Selector Guide

PART	MAXIMUM DUTY CYCLE	SLOPE COMPENSATION
MAX5014CSA	85%	Yes
MAX5014ESA	85%	Yes
MAX5015CSA	50%	No
MAX5015ESA	50%	No

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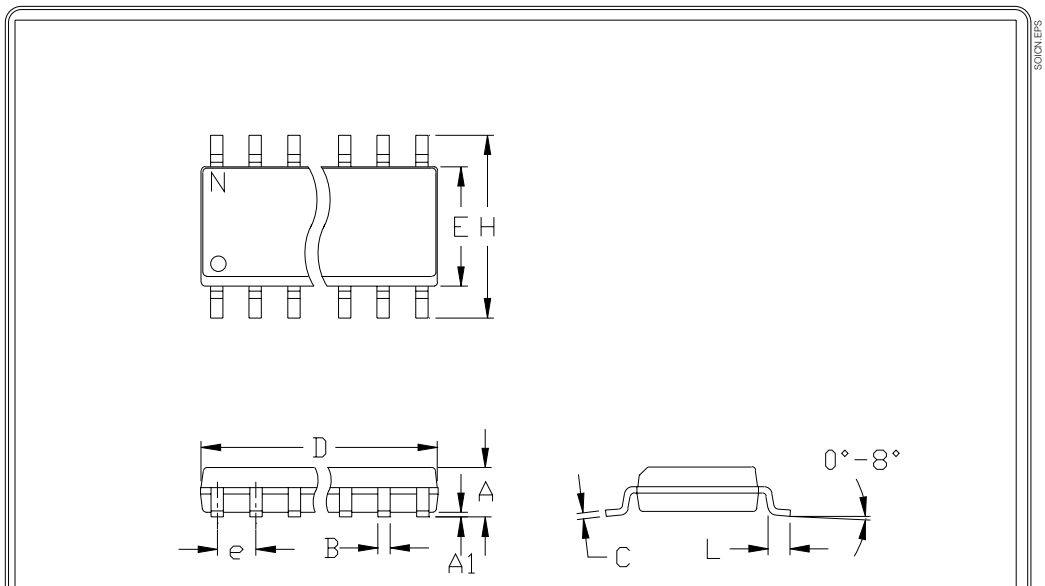
Package Information



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050		1.27	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	N	MS012
D	0.189	0.197	4.80	5.00	8	A
D	0.337	0.344	8.55	8.75	14	B
D	0.386	0.394	9.80	10.00	16	C

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
3. LEADS TO BE COPLANAR WITHIN .102mm (.004")
4. CONTROLLING DIMENSION: MILLIMETER
5. MEETS JEDEC MS012-XX AS SHOWN IN ABOVE TABLE
6. N = NUMBER OF PINS

MAXIM	PACKAGE FAMILY OUTLINE: SOIC .150"	1/1	21-0041 A
120 SAN GABRIEL DR SUNNYVALE CA 94086 FAX (408) 737 7194 PROPRIETARY INFORMATION	TITLE		DOCUMENT CONTROL NUMBER REV

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Maxim Integrated:

MAX5014CSA+ MAX5014CSA+T MAX5014ESA+ MAX5014ESA+T MAX5015CSA+ MAX5015CSA+T MAX5015ESA+ MAX5015ESA+T MAX5014CSA MAX5014CSA-T MAX5014ESA MAX5014ESA-T MAX5015CSA MAX5015CSA-T MAX5015ESA MAX5015ESA-T MAX5015ESA-G077 MAX5015ESA-TG077